Achuta Kadambi

Assistant Professor Electrical Engineering Department University of California, Los Angeles

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Research

Imaging the invisible by blending optics and computer science, topics usually studied separately. Applications to cyber-physical systems, transportation, and healthcare.

Education

PhD	MIT Media Lab / EECS	2017
MS	Yale	2012
BS	UC Berkeley	2011

Awards

2019 2019 2018 2016 2016 2016 2016 2015 2015 2013 2011	CRII Research Initiation Award, NSF Forbes 30 Under 30 (Science) Best Paper Award, IEEE ICCP Lemelson-MIT Student Prize Rahamimoff Award, US-Israel Science Foundation Best Papers Special Issue Selection, ICCV Best Presentation Award, CVPR VIEW workshop World Changing Idea, Scientific American Qualcomm Innovation Fellowship Draper 4-year PhD Fellowship Regent and Chancellor Scholar, UC Berkeley
	Visiting Positions
2017 2016 2015 2014	Visiting researcher, Harvard Medical School, Boston MA Visiting student, Technion Electrical Engineering, Israel Intern, Microsoft Research, Redmond WA Intern, Mitsubishi Electric Research Lab (MERL), Cambridge MA
	Keynote/Plenary Talks
2017 2016	Computer Vision and Information Processing Society of Japan, Nagoya JP Honeywell Technology Symposium, Phoenix, AZ
	Invited Talks
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2017	University of Tokyo, Tokyo JP
2017	University of Tokyo, Tokyo JP Cymer Semiconductor Equipment, San Diego CA
2017 2016	University of Tokyo, Tokyo JP Cymer Semiconductor Equipment, San Diego CA Columbia CS, New York City, NY
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2014 2014 2014 2014 2014 2014 2013 2013 2013	Qualcomm Research, San Diego, CA Technion Institute of Technology, Haifa, Israel Microsoft iToF Workshop, Ein Gadi, Israel Indian Institute of Technology, Bombay, India SIGGRAPH, Vancouver, Canada International Conference on Computational Photography, Santa Clara, CA OSA Computational Optical Sensing and Imaging, Arlington, VA Nokia Research, Bangalore, India SIGGRAPH Asia, Hong Kong
	Teaching
T.6 T.5 T.4 T.3 T.2 T.1 T.0	Instructor, ECE.239, "Computational Imaging", UCLA Fall '18. Coinstructor, MAS.S65, "Society of Autonomous Vehicles", MIT Spring '18. Coinstructor, MAS.132/532, "Mathematical Methods in Imaging", MIT Spring '14. Coinstructor, "Computational Time of Flight Imaging", IEEE ICCV 2015. Coinstructor, "Computational 3D Imaging", ACM SIGGRAPH 2015. Coinstructor, "3-D Imaging with Time of Flight Cameras", ACM SIGGRAPH 2014. Teaching assistant for various courses.
	Professional Service
	Program committee ICCP 2019 Program committee CVPR 2019 Program committee ICCP 2018 Program committee CVPR 2018 Program committee ICCP 2017 Program committee ICCP 2017 Program committee ICCV PBDL Workshop 2017 Program committee CVPR 2016 Organizer Marvin Minsky Memorial Lecture Reviewer SIGGRAPH Reviewer SIGGRAPH Asia Reviewer ICCV Reviewer ICCV Reviewer ECCV Reviewer ICCP Reviewer IEEE Transactions on Computational Imaging (TCI) Reviewer Various OSA journals University Service MIT, undergrad admissions committee University Service Lemelson-MIT student prize, selection committee IEEE, ACM, and OSA Member

Textbook

TB.1 *Computational Imaging (235 pages)* Published by **MIT Press**, To appear online in 2019 and in print by 2020. Joint work with A. Bhandari and R. Raskar.

Full Papers

- P.11 T. Maeda, A. Kadambi, Y. Schechner, R. Raskar. *Dynamic Heterodyne Interferometry*. IEEE ICCP 2018. **(Best Paper Award)**
- P.10 A. Kadambi, R. Raskar. *Rethinking Machine Vision Time of Flight with GHz Heterodyning*. IEEE Access 2017
- P.9 A. Kadambi, J. Schiel, R. Raskar. *Frequency-domain Time of Flight Cameras for Multi-depth Imaging*. Under revision for IJCV 2018.
- P.8 A. Kadambi, V. Taamazyan, B. Shi, R. Raskar. *Depth sensing using geometrically constrained polarization normals*. In IJCV 2017. (Best Papers Issue)
- P.7 A. Kadambi, J. Schiel, R. Raskar. *Macroscopic Interferometry: Rethinking Depth Estimation with Frequency-Domain Time-of-Flight*. In IEEE CVPR (Oral), 2016. (3% acceptance rate)
- P.6 A. Kadambi, H. Zhao, B. Shi, R. Raskar. *Occluded Imaging with Time of Flight Sensors*. In ACM Transactions on Graphics (pres SIGGRAPH 2016)
- P.5 A. Kadambi, V. Taamazyan, B. Shi, R. Raskar. *Polarized 3D: Enhanced 3D sensing fusing depth and polarization cues.* In IEEE ICCV (Oral), 2015 (3% acceptance rate)
- P.4 N Naik, A Kadambi, C Rhemann, S Izadi, R Raskar, SB Kang. *A Light Transport Model for Mitigating Multipath Interference in TOF Sensors*. In IEEE CVPR, 2015.
- P.3 A. Bhandari, A. Kadambi, R. Whyte, C. Barsi, M. Feigin, A. Dorrington, R. Raskar. *Resolving multi-path interference in time-of-flight imaging via modulation frequency diversity and sparse regularization.* In Optics Letters 2014.
- P.2 A. Kadambi, A. Bhandari, R Whyte, A Dorrington, R Raskar. *Demultiplexing Illumination via Low Cost Sensing and Nanosecond Coding*. In IEEE ICCP (Oral), 2014.
- P.1 A. Kadambi, R. Whyte, A. Bhandari, L. Streeter, C. Barsi, A. Dorrington, R. Raskar. *Coded time of flight cameras: sparse deconvolution to address multipath interference and recover time profiles.* In ACM Transactions on Graphics (pres SIGGRAPH Asia 2013)

Selected Conference Papers

- C.5 A. Kadambi*, A. Cramer*, D Lanza, R Raskar, R Gupta. *Computational X-ray Imaging with Document Scanners* OSA COSI, 2018
- C.4 A. Kadambi, J. Schiel, R. Raskar. *Macroscopic Interferomery with Electrons rather than*

- Photons. In OSA IS, 2016.
- C.3 A. Kadambi, P. Boufounos. *Compressive, Coded Aperture, 3-D LIDAR*. In IEEE ICASSP, 2015.
- C.2 A. Bhandari, A. Kadambi, R. Raskar. *Sparse Linear Operator Identification without Sparse Regularization?* In IEEE ICASSP, 2014.
- C.1 A. Kadambi, H. Ikoma, X. Lin, G. Wetzstein, R. Raskar. Subsurface Enhancement through Sparse Representations of Multispectral Direct/Global Decomposition. In OSA Computational Sensing and Imaging (COSI), 2013.

US Patent Filings

- US.13 A. Kadambi, T. Maeda, A. Bhandari, B. Heshmat, R. Raskar. *Undisclosed LIDAR technique*. MIT Case #19963T
- US.11 A. Bhandari, C. Barsi, A. Kadambi, R. Raskar. *Methods and Apparatus for FLI with pulsed light*. US Patent App. 15/487,438
- US.10 A. Kadambi, A. Bhandari, R. Whyte, R. Raskar. *Optical frequency domain illumination multiplexing*. MIT Case #16702T
- US.8 A. Kadambi, R. Raskar, A. Pan, R. Gupta. *Methods and Apparatus for X-Ray Imaging from Temporal Measurements*. US Patent App. 15/58,169
- US.9 A. Kadambi, V. Taamazyan, B. Shi, R. Raskar. *Methods for enhancing 3D maps with polarization*. US Patent App. 14/979,433 (Granted by USPTO in 2019)
- US.12 A. Bhandari, C. Barsi, A. Kadambi, R. Raskar. *Methods and Apparatus for FLI with modulated light*. US Patent App. 15/487,435 (Granted by USPTO in 2019)
- US.7 A. Kadambi, J. Schiel, V. Taamazyan, A. Bhandari, R. Raskar. *Macroscopic Interferometry*. US Patent App. 15/431,713 (Granted by USPTO in 2018)
- US.6 P. Boufounos, A. Kadambi. *Intensity-based Depth Sensing System and Method*. US Patent App. 14/628,360 (Granted by USPTO in 2018)
- US.5 A. Kadambi, H. Zhao, B. Shi, A. Bhandari, R. Raskar. *Methods and Apparatus for Virtual Sensor Array* US Patent App. 14/795,113 (Granted by USPTO in 2018)
- US.4 A. Kadambi, R. Whyte, A. Bhandari, L. Streeter, C. Barsi, A. Dorrington, R. Raskar. *Methods and Apparatus for Coded Time-of-Flight Camera*. US Patent App. 14/523,708 (Granted by USPTO in 2017)
- US.3 P. Boufounos, A. Kadambi. *Depth Sensing Using Optical Pulses and Fixed Coded Aperture*. US Patent App. 14/551,394 (Granted by USPTO in 2017)

- US.2 A. Kadambi, A. Bhandari, R. Raskar. *Methods and Apparatus for Demultiplexing Illumination*. US Patent App. 14/690,159 (Granted by USPTO in 2016)
- US.1 R. Raskar, A. Kadambi, A. Bhandari, C. Barsi. *Methods and apparatus for multi-frequency camera*. US Patent App. 14/280,284 (Granted by USPTO in 2016)